深圳市智诚光电发展有限公司

PRODUCT SPECIFICATIONS

For Customer:
□ : APPROVAL FOR SPECIFICATION

Customer Model No._____ □ : APPROVAL FOR SAMPLE

Module No.: EBL050WV40-01

Date : 2020.09.232

Version :A

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For Customer's Acceptance:

Approved By	Comment

PREPARED	CHECKED	VERIFIED BY QA DEPT	VERIFIED BY R&D DEPT

2. Revision Record

Date	Rev.No.	Page	Revision Items	Prepared
2020.09.23	Α		The first release	
	-77-		HINTER THE	

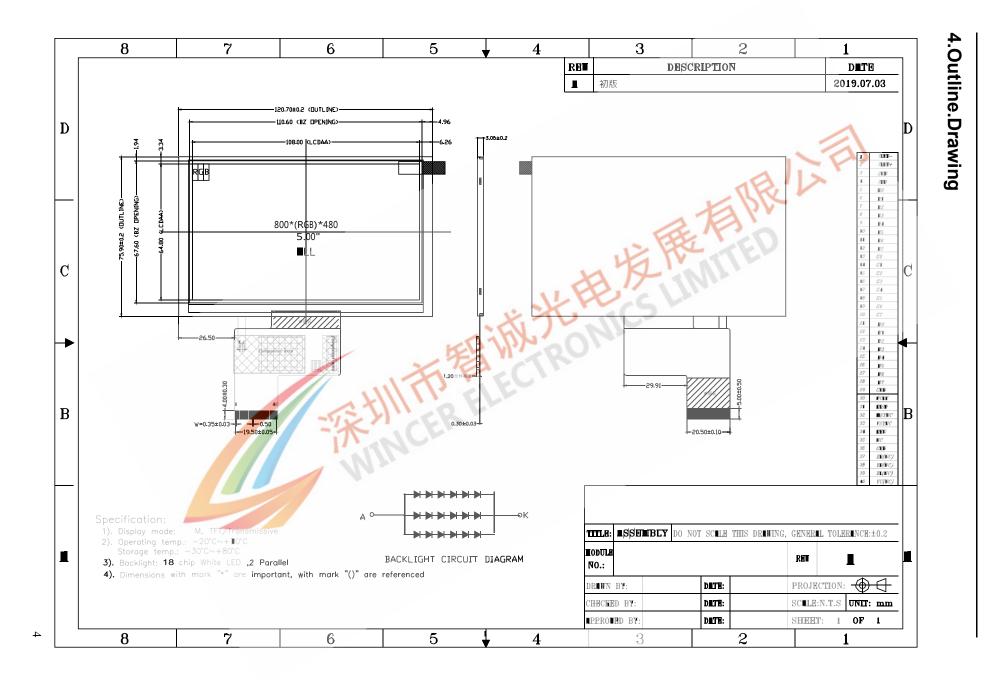
3. General Specifications

EBL050WV40-01 is a TFT-LCDmodule.It is composed of a TFT-LCDpanel, driverIC, FPC, a back light unit. The 5.0" display area contains 800 x 480 pixels and can display up to 16.7M colors. This product accords with RoHS environmental criterion.

Item	Contents	Unit	Note
LCD Type	Normally Black, Transmissive	-	
Display color	16.7M	一眼	
Viewing Direction	ALL	O' Clock	
Operating temperature	-207+70	°C	
Storage temperature	-30~+80	°C	
Module size	120.70(W)×75.80(H)×3.05(T)	mm	2
Active Area(W×H)	108.00(W)×61.80(H)	mm	
Number of Dots	800×RGB×480	dots	
Backlight	12-LEDs (white)	pcs	
Data Transfer	RGB interface	-	

Note 1: Color tune is slightly changed by temperature and driving voltage.

Note 2: Without FPC and Solder.EBL050WV40-01



5. Absolute Maximum Ratings(Ta=25°C)

5.1 Electrical Absolute Maximum Ratings.(Vss=0V ,Ta=25°C)

Item	Symbol	Min.	Max.	Unit	Note
Power Supply Voltage	VDD	-0.3	3.6	V	
Input Voltage	Vın	-0.3	VDD+0.5	V	1 · 2
Current of LED	ILED	0	20	mA	

Notes:

- If the module is above these absolute maximum ratings. It may become permanently damaged. Using the module within the following electrical characteristic conditions are also exceeded, the module will malfunction and cause poor reliability.
- 2. VDD>V_{SS} must be maintained.
- 3. Please be sure users are grounded when handing LCD Module.
- 5.2 Environmental Absolute Maximum Ratings.

Item	Storage		Operat	ting	Note
	MIN.	MAX.	MIN.	MAX.	
Ambient Temperature	-30 ℃	80 ℃	-20 ℃	70 ℃	1,2
Humidity	-	-	-	-	3

- 1. The response time will become lower when operated at low temperature.
- 2. Background color changes slightly depending on ambient temperature.

The phenomenon is reversible.

3. Ta<=40°C:85%RH MAX.

Ta>=40 $^{\circ}$ C:Absolute humidity must be lower than the humidity of 85%RH at 40 $^{\circ}$ C.

6. Electrical Specifications and Timing Characteristics

Paramet	ter	Symbol	Condition	Min	Тур	Max	Unit	Note
Power su	wer supply VDD		Ta=25℃	2.8	3.3	3.6	V	
Input	'H'	V _{IH}	VDD=3.3V	0.7VDD	-	VDD	V	
voltage	'Ľ'	VIL	VDD=3.3V	0	-	0.3VDD	V	
Curren	it	I _{CC1}	Normal mode	-	-	-	mA	2
Consump	Consumption I _{CC2}		Sleep mode	-	0.03	0.09	mA	2

6.1 Electrical characteristics(Vss=0V ,Ta=25 $^\circ\!{\rm C}$)

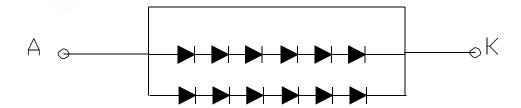
Note:

1:When an optimum contrast is obtained in transmissive mode.

2: Tested in 1×1 chessboard pattern

6.2 LED backlight specification(VSS=0V,Ta=25°C)

Item	Symbol	Condition	Min	Тур	Max	Unit	Note
Supply voltage	-	-	16.8	17	18	V	1
Supply current	_f	-	-	40	-	mA	2



Note:

1: VLED=VLED(+)-VLED(-).

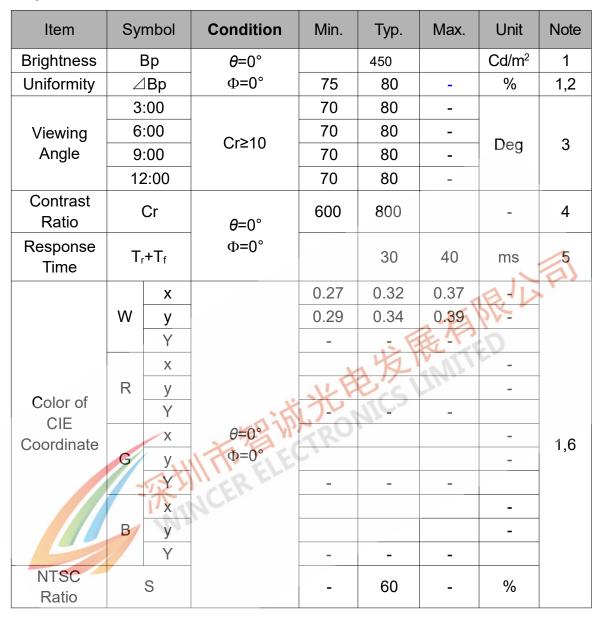
2:The current of LED is 20mA.

A LED drive in constant current mode is recommended.

6.3 Interface signals

Pin	Symbol	Description.	
1	LED_K	Backlight LED Ground	
2	LED_A	Backlight LED Power	
3	GND	GND	
4	VDD	Power supply	
5~12	R0-R7	Red data bus	
13~20	G0-G7	Green data bus	
21~28	B0-B7	Blue data bus	
29	GND	GND # HERS	
30	PCLK	Data clock	
31	DISP	Standby mode select pin	
32	HSYNC	Line SYNC signal	
33	VSYNC	Frame SYNC signal	
34	DE	Data Enable Input	
35	NC	NC	
36	GND	GND	
37	X1	Touch Panel Control Pin	
38	Y1	Touch Panel Control Pin	
39	X2	Touch Panel Control Pin	
40	Y2	Touch Panel Control Pin	

7. Optical Characteristics



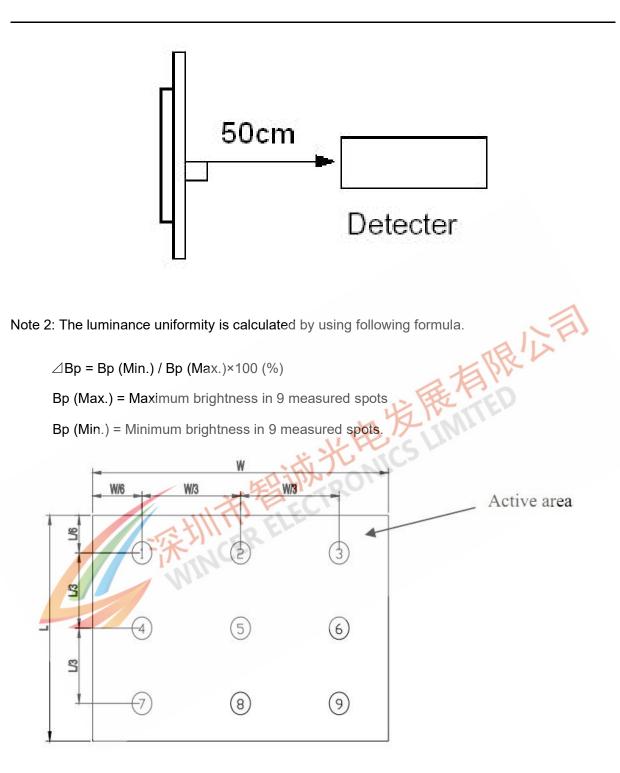
Note : The parameter is slightly changed by temperature, driving voltage and materiel

Note 1: The data are measured after LEDs are turned on for 5 minutes. LCM displays full white. The brightness is the average value of 9 measured spots. Measurement equipment PR-705 (Φ8mm)

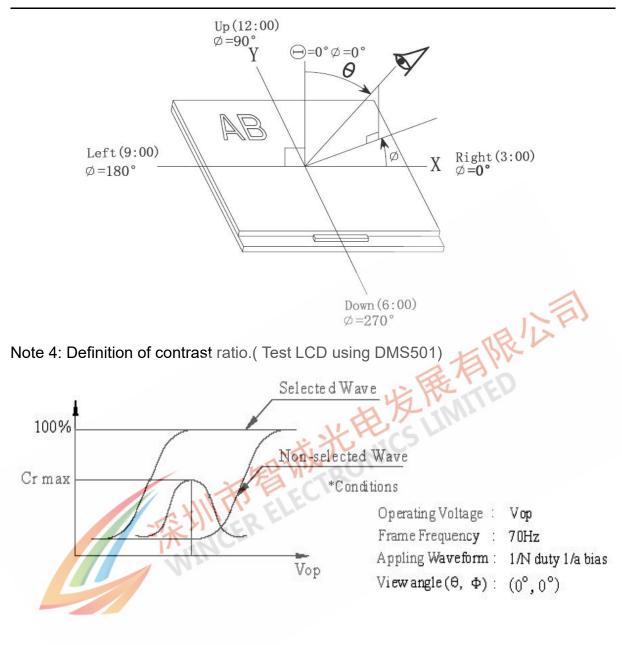
Measuring condition:

- Measuring surroundings: Dark room.
- Measuring temperature: Ta=25°C.
- Adjust operating voltage to get optimum contrast at the center of the display.

Measured value at the center point of LCD panel after more than 5 minutes while backlight turning on.



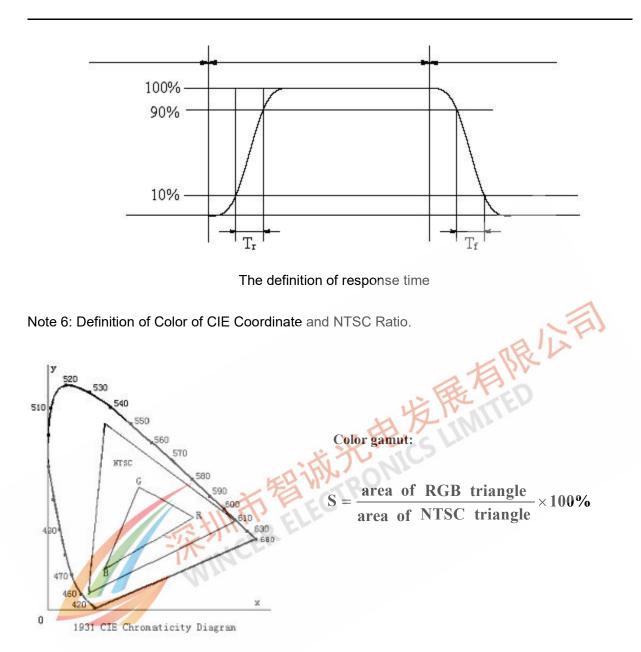
Note 3: The definition of viewing angle: Refer to the graph below marked by θ and Φ



 $Contrast \ ratio(Cr) = \frac{Brightness \ of \ selected \ dots}{Brightness \ of \ non-selected \ dots}$

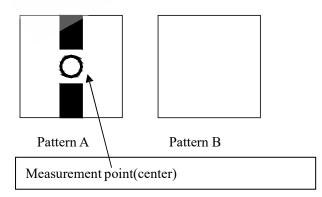
Note 5: Definition of Response time. (Test LCD using DMS501):

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes.Refer to figure as below.



Note 7: Definition of cross talk.

Cross talk ratio(%)=|pattern A Brightness-pattern B Brightness|/pattern A Brightness*100



Electric volume value=3F+/-3Hex

8. Reliability Test Items and Criteria

No	Test Item	Test condition	Criterion
1	High Temperature Storage	80℃±2℃ 96H Restore 2H at 25℃ Power off	
2	Low Temperature Storage	$-30^{\circ}C \pm 2^{\circ}C 96H$ Restore 2H at 25°C Power off	1. After testing,
3	High Temperature Operation	berature Operation $70^{\circ}C \pm 2^{\circ}C 96H$ Restore 2H at 25°C Bower op	
4	Low Temperature Operation	-20℃±2℃ 96H Restore 4H at 25℃ Power on	happen. 2. Total current consumption should not be more than twice
5	High Temperature/Humidity Operation	60℃±2℃ 90%RH 96H Power on	of initial value.
6	Temperature Cycle	-30°C →80°C 30min 5min 30min after 5 cycle, Restore 2H at 25°C Power off	EV
7	Vibration Test	10Hz~150Hz, 100m/s², 120min	Not allowed cosmetic
8	Shock Test	Half- sine wave,300m/s ² ,11ms	and electrical defects.
9	ESD Test	Air discharge:±8KV, Contact discharge:±4KV	

Note: Operation: Supply 3.3V for logic system.

The inspection terms after reliability test, as below

ITEM	Inspection
Contrast	CR>50%
IDD	IDD<200%
Brightness	Brightness>60%
Color Tone	Color Tone+/-0,05

9 Quality level

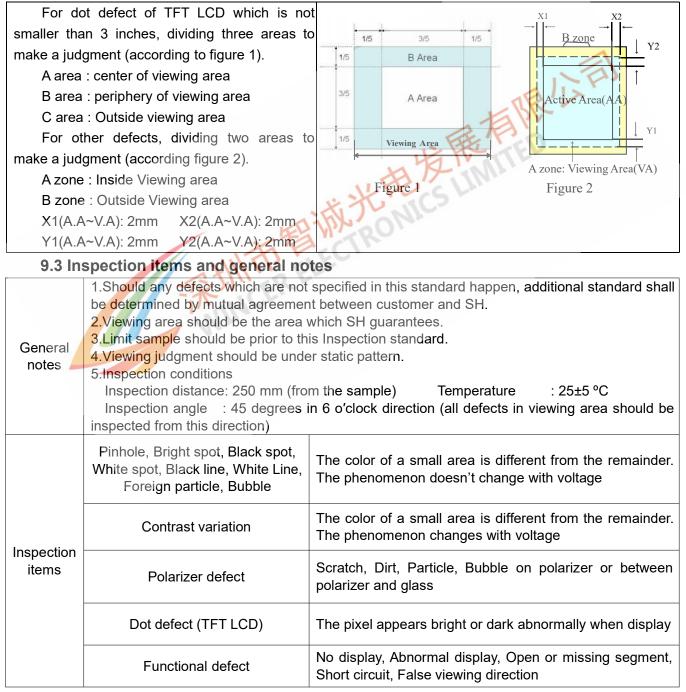
9.1 Classification of defects

Major defects (MA): A major defect refers to a defect that may substantially

degrade usability for product applications, including all functional defects(such as no display, abnormal display, open or missing segment, short circuit, missing component), outline dimension beyond the drawing, progressive defects and those affecting reliability.

Minor defects (MI): A minor defect refers to a defect which is not considered to be able to substantially degrade the product application or a defect that deviates from existing standards almost unrelated to the effective use of the product or its operation, such as black spot, white spot, bright spot, pinhole, black line, white line, contrast variation, glass defect, polarizer defect, etc.

9.2 Definition of inspection range



Glass defect	Glass crack, Shaved corner of glass, Surplus glass
PCB defect	Components assembly defect

9.4 Outgoing Inspection level

Outgoing Inspection	Increation conditions	Inspection		I		
standard	Inspection conditions	Min.	Max.	Unit	IL	AQL
Major Defects	See 8.3 general notes		See 8.5		II	0.065
Minor Defects	See 8.3 general notes	S ee 8.5		11	0.065	
Note : Sampling standard conforms to GB2828					1	
9.5 Inspection Items and Criteria						

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				to pr					
Inspection items			Judgment standard						
			Category		Acceptable number				
					A zone	B zone			
	Black spot, White spot, Pinhole, Foreign Particle, Particle in or on glass, Scratch on glass			Φ<=0.20	Neglected	Neglected			
1		ble, Foreign cle, Particle on glass, $\Phi = (a+b)/2(mm)$	В	0.20<Φ<=0.25	3	Neglected			
			С	0.25<Φ<=0.3	2	Neglected			
			D	0.3<Ф<=0.4	1	3			
		(a/b<2.5)	Е	0.4<Ф<=0.5	0	2			
			Тс	tal defective point(B,C)	1	-			
	Black line, White line, and Particle Between Polarizer and glass, Scratch on glass	and Particle veen rizer and s, Scratch on	А	W<=0.03	Neglected	Neglected			
			В	0.03 <w<=0.05 L<=3.0</w<=0.05 	3	Neglected			
2			с	0.05 <w<=0.1 L<=3.0</w<=0.1 	2	Neglected			
2			D	0.05 <w<=0.1 L<=4.0</w<=0.1 	1	3			
			Е	W>0.1 L>4.0	0	2			
			Тс	otal defective point(B,C)	1	-			
3	Bright spot		any size		none	none			
4	Contrast		Α	Φ<0.2	Neglected	Neglected			

	·					1]			
	variation		В	0.2<Ф<=0.3	2				
		b	С 0.3<Ф<=0.4		1				
			D	0.4<Φ	0				
			Total defective point(B,C)		3				
5	Bubble inside cell		any size none none						
	Polarizer defect								
6	(if Polarizer is used)	Bubble, dent and convex	A	Φ<= 0.1	Neglected	Neglected			
			В	0.1 <Ф<=0.2	2	Neglected			
			С	0.2 <Ф<=0.3	TRIL	2			
7	Surplus glass	Stage surplus glass	B<=0.3mm Should not influence outline dimension and assembling.						
8	Open segment or open common			Not permitted					
9	Short circuit			Not permitted					
10	False viewing direction			Not permitted					
11	Contrast ratio uneven			According to the limit specimen					
12	2 Crosstalk		According to the limit specimen						
13	Black /White spot(display)			Refer to item 1					
14	Black /White line(display)			Refer to item 2					

				Judgment standard	
		Inspection items		Category(application: B zone)	Acceptable number
15	Glass defect crack	i)The front of lead terminals i)The front of lead terminals ii)Surrounding crack-non-contact side seal ii)Surrounding crack-non-contact side Inner border line of the seal Outer border line of the seal ii)Surrounding crack-contact side ii)Surrounding crack-contact side	A B		number
		w b c	В	Glass crack should not cover patterns u and alignment mark and patterns.	

	Inspection items	Judgment standard Category(application: B zone)
PCB defect	Component soldering: No cold soldering \short \circopen circuit \ burr \tin ball The flat encapsulation component position deviation must be less than 1/3 width of the pin (Pic.1); the sheet component deviation: Pin deviates from the pad and contact with the near components is not permitted (Pic.2) lead defect: The lead lack must be less than 1/3 of its width; The lead burr must be less than 1/3 of its width; The lead burr must be less than 1/3 of the seam; Impurities connect with the near leads is not permitted Connector soldering: Soldering tin is at contact position of the plug and socket is not permitted No foundation is scald Serious cave distortion on plug and socket contact pin is not permitted	Component U U U U U U U U U U U U U U U U U U U
	The insulative coat of the lead must join into the PCB; the protected glue must envelop to the insulative coat.	Glue PCB Insulative coat
	_	PCB defect Connector soldering: No cold soldering short sopen circuit sour stin ball The flat encapsulation component position deviation must be less than 1/3 width of the pin (Pic.1); the sheet component deviation: Pin deviates from the pad and contact with the near components is not permitted (Pic.2) lead defect: The lead lack must be less than 1/3 of its width; The lead burr must be less than 1/3 of the seam; Impurities connect with the near leads is not permitted Occenter soldering: Soldering in is at contact position of the plug and socket is not permitted No foundation is scald Serious cave distortion on plug and socket contact pin is not permitted Glue on root of the speaker receiver and motor lead: The insulative coat of the lead must join into the PCB; the protected glue must

10. Precautions for Use of LCD Modules

10.1 Handling Precautions

- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 10.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 10.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 10.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 10.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- -- Water
- Ketone
- Aromatic solvents

10.1.6 Do not attempt to disassemble the LCD Module.

- 10.1.7 If the logic circuit power is off, do not apply the input signals.
- 10.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct

assembly and other work under dry conditions.

d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

10.2 Storage precautions

- 10.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 10.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition 有限公司 is:

0°C ~ 40°C Temperature :

Relatively humidity: ≤80%

- 10.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 10.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.